

ESL1601-2110

SLED Butterfly 1600nm

Revision: 1.0
Date: 01-09-2011

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1. SCOPE

1.1 PURPOSE

The purpose of this document is to specify the electro-optical performance and dimensions of superluminescent light emitting diode (SLED) Butterfly.

1.2 RESPONSIBILITY

EXALOS is responsible for establishing, implementing and maintaining this procedure. The Quality representative shall ensure that a timely Engineering Change Notice (ECN) is issued in accordance with EXALOS procedure for any changes.

2. REFERENCE DOCUMENT

- EXS-WI-0001 Visual Inspection Criteria SLED Chip on Submount Procedure
- MIL STD 883 C method.
- Bellcore GR-468-CORE.

3. ELECTRO-OPTICAL PERFORMANCE ($T_{SLED} = 20^{\circ}C$)

Parameter	Symbol	Cond.	Min	Typ	Max	Unit
Operating Current	I_{op}		0		200	mA
Power in SMF	P_o	$I_{op,max}$	0.5	1		mW
Center Wavelength	λ_c	$I_{op,max}$	1580	1600	1620	nm
Bandwith FWHM		$I_{op,max}$	80	90		nm
Spectral ripple [RB=0.1nm]		$I_{op,max}$		0.1	0.2	dB

4. ABSOLUTE MAXIMUM RATINGS

Stresses beyond the absolute maximum ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Parameter	Symbol	Cond.	Min	Max	Unit
Forward current	I_F	$I_{F,max}$		250	mA
Reverse voltage	V_R			-2	V
Forward voltage	V_F	$I_{F,max}$		2	V
Storage temperature	T_{stg}		-40	85	°C
Operating temperature	T_{op}	$I_{F,max}$	-20	65	°C
Storage humidity	<30°C		5	95	% r.h.
	>30°C			85	% r.h.
Thermoelectric cooler voltage	V_{tec}			2.5	V
Thermoelectric cooler current	I_{tec}			1.8	A
Thermistor Resistance	R_{th}	20°C	12.5		KΩ
Thermistor constant	B		3892		K
Lead soldering temperature				260	°C
Lead soldering duration				10	s
ESD		human b.m		500	V

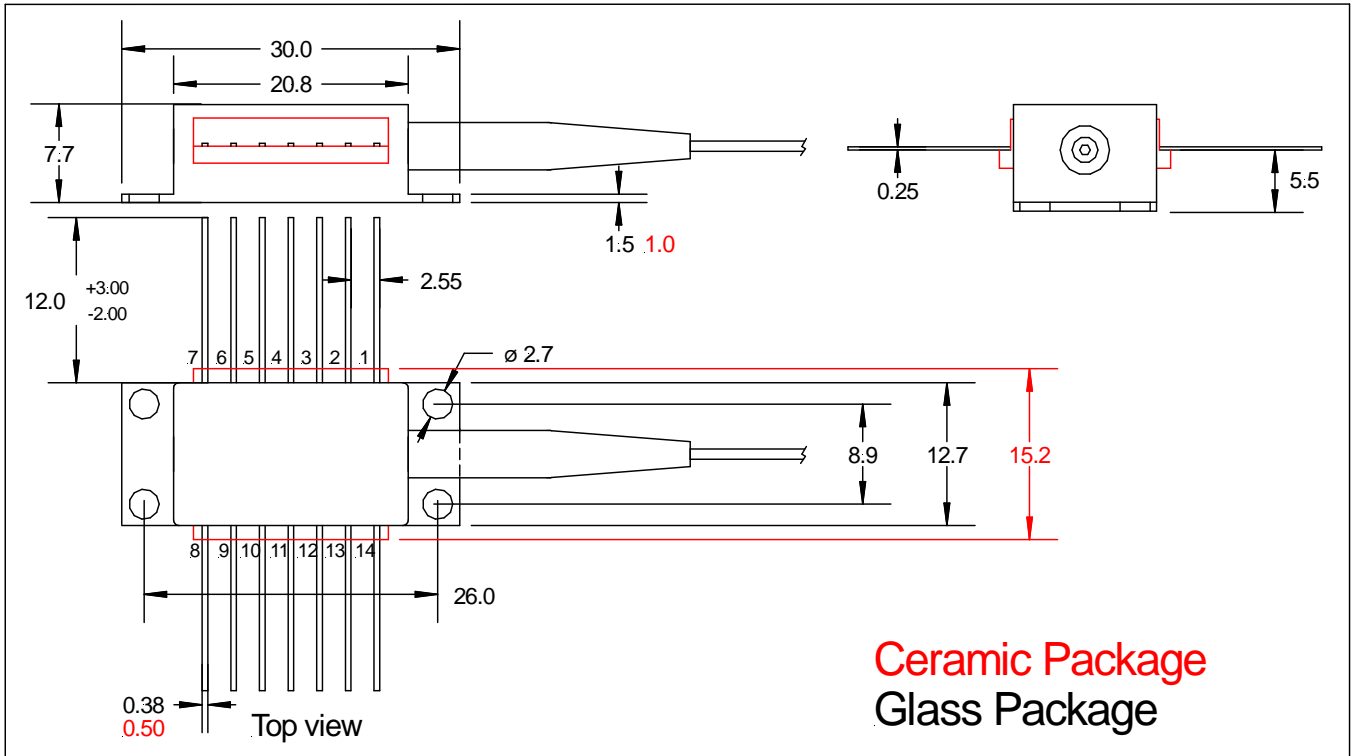
5. SCREENING

The produced 1600nm SLED Module is required to meet all operating conditions specified in Table 3, Electro-Optical Performance Specifications after being subjected to the following screening tests.

Test Item	Test Conditions	Reference
Seal	Fine: Condition A1 Gross: Condition C	MIL-STD-883, Method 1014
Temperature Cycling	-40°C to +85°C, ramp rate $\geq 5^\circ\text{C}/\text{min}$ 10 cycles	MIL-STD-883, Method 1010

6. PACKAGE DIMENSIONS [mm]

3rd Angle projection  
Tolerances : .X ± 0.25 mm
.XX ± 0.05 mm



Butterfly Package			
Pin	Function	Pin	Function
1	TEC (+)	8	NC
2	THERMISTOR	9	NC
3	NC	10	SLED ANODE (+)
4	NC	11	SLED CATHODE (-)
5	THERMISTOR	12	NC
6	NC	13	NC
7	NC	14	TEC (-)

7. FIBRE AND CONNECTOR

Part	Description
SM Fibre	SMF-28, 9/125 µm
Tight buffer secondary coating	900 µm
Fiber pigtail length [min]	1 m
Optical connector	FC/APC Narrow Key (2.0mm)

8. IMPORTANT NOTES

1. Avoid electrostatic discharges, which may destroy the SLED.
2. Never use the bare die without heat sinking.
3. Adequate eye protection against laser radiation should be used while handling and operating the module.
4. EXALOS declines any responsibility if the device is used in applications where human life may be endangered.
5. Back reflections may influence the output power and spectral characteristics of the SLED. The use of optical isolators and/or angled connectors is recommended. Back reflections of less than -30dB are recommended.

9. ORDERING INFORMATION

Please use the following code system to order products from EXALOS:

Standard product: The Standard product is **ESL1601-2110**.

